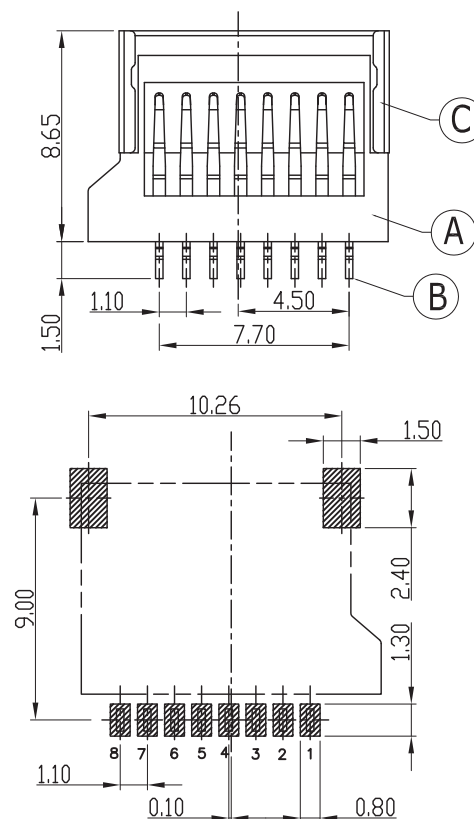
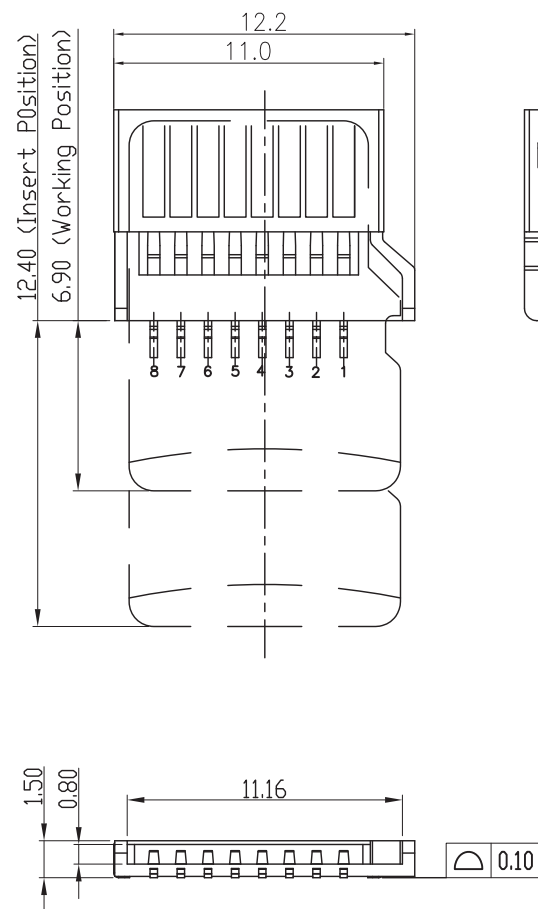


SWITCH CIRCUIT		MATERIAL AND FINISH AS BELOW	
WHEN CARD IS EJECTED	WHEN CARD IS INSERTED	A Housing	LCP UL94V-0 Black
		B Contact	Phosphor Bronze C5191, Contact Area: 1u" Gold
		C Shell	Stainless Steel SUS304, Nickel Plating Gold Flash on Solder Area.



RECOMMENDED PCB LAYOUT

SPECIFICATION:

1. ELECTRICAL

- 1.1 Current Rating: 0.5A
- 1.2 Voltage Rating: 100V AC/DC
- 1.3 Contact Resistance: 50mΩ
- 1.4 Insulation Resistance: 1000MΩ
- 1.5 Dielectric Withstanding Voltage: 500VDC

2. MECHANICAL

- 2.1 Durability: 10000 Cycle
- 2.2 Insertion Force: 9.8N max.
- 2.3 Extraction Force: 9.8N max.

3. ENVIRONMENTAL

- 3.1 Operating temperature range: -40°C~+85°C
- 3.2 Storage temperature range: -40°C~+85°C

4. SOLDER ABILITY

- 4.1 Recommended IR Reflow Temperature: 260°C

DAT2	CD/DAT3	CMD	VDD	CLK	VSS	DAT0	DAT1			
P1	P2	P3	P4	P5	P6	P7	P8	P9	P10	P11

PIN ASSIGNMENT

RoHS Compliant

TOLERANCES ARE

照片框

ORDER INFORMATION

TFC-WXBE10H15-08-LF
 SERIES | | | | LEADFREE
 90°SMT | | | | 08 WAY
 | | | | HIGH 1.5mm
 | | | | EAR 1.0mm
 | | | | BOTTOM CONTACT
 | | | | NON PUSH

MORETHANALL
 PCB CONNECTORS
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www.morethanall.com

DRAWING BY CY

CHECKED BY GENIUS

UNIT / mm

SCALE 1 : 1

DATE

SIZE A4

PPOJECTION

X. ± 0.30
 .X ± 0.25
 .XX ± 0.20
 .XXX ±
 ANG ± 5°

DESCRIPTION: Micro SD Socket Without Cover